



Connectors > PCB Connectors > Card Edge Connectors > PCI & PCI Express Connectors



Connector System: **Board-to-Board**

Number of Positions: **184**

Centerline (Pitch): **1.27 mm [.05 in]**

Termination Post & Tail Length: **3.56 mm [.14 in]**

Contact Mating Area Plating Material Thickness: **[30 µin]**

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Connector System	Board-to-Board

Configuration Features

Number of PCB Mount Retention Features	3
Number of Positions	184
PCB Mount Orientation	Vertical
Ejector	Without

Electrical Characteristics

Operating Voltage	203 VAC
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Body Features

Product Weight	12.58 g
Primary Product Color	Natural

Contact Features

PCB Contact Termination Area Plating Material Thickness	2.54 µm
Contact Underplating Material	Nickel



Contact Mating Area Plating Material	Gold (Au)
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Contact Base Material	Phosphor Bronze
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PCB Contact Termination Area Plating Material	Tin
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	30 μin
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Termination Features

Termination Method to PCB	Through Hole - Solder
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Termination Post & Tail Length	3.56 mm [.14 in]
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Mechanical Attachment

Connector Mounting Type	Board Mount
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Housing Features

Housing Material	High Temperature Thermoplastic
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Centerline (Pitch)	1.27 mm [.05 in]
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Dimensions

PCB Thickness (Accepted)	1.57 mm [.062 in]
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Connector Length	128 mm [5.039 in]
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Connector Height	13.97 mm [.55 in]
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Connector Width	8.88 mm [.35 in]
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Usage Conditions

Operating Temperature Range	-55 – 85 °C [-67 – 185 °F]
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Operation/Application

Circuit Application	Signal
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Industry Standards

Bus Type	PCI
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Packaging Features

Packaging Method	Box
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Packaging Quantity	35
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Product Compliance

For compliance documentation, visit the product page on [TE.com](https://www.te.com)>

EU RoHS Directive 2011/65/EU	Compliant
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EU ELV Directive 2000/53/EC	Compliant
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China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JAN 2025 (247) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



TE Part # 1734774-1
PCI EXP 3.1L 36 POS WHT G/F



TE Part # 5145154-1
CONNECTOR, 60 DUAL POSITION, .



TE Part # 5-2337939-4
PCIE GEN4 CON,SMT,164POS,30u",
MYLAR,HT

Customers Also Bought



TE Part #3-1393210-3
T9AS5D12-12



TE Part #794210-1
20P MINI UMNL2 PLUG HSG UL94V0



TE Part #1-2176510-6
CJP 500W 27R 5% Lead



TE Part #CAT-C339-SQ1
Wirewound Resistor: Vertical Mount



Documents

Product Drawings

CONNECTOR ASSEMBLY, DUAL POSITIONS, .050

English

CAD Files

3D PDF

3D

Customer View Model

[ENG_CVM_CVM_1-5145165-2_D.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1-5145165-2_D.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1-5145165-2_D.3d_stp.zip](#)

English

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Product Specifications

Application Specification

English

Agency Approvals

UL Report

English

UL Report

English

1-5145165-2

Board-to-Board, 184 Position, 1.27 mm [.05 in] Centerline, Vertical, Natural, 13.97 mm [.55 in] Height, PCI & PCI Express Connectors

